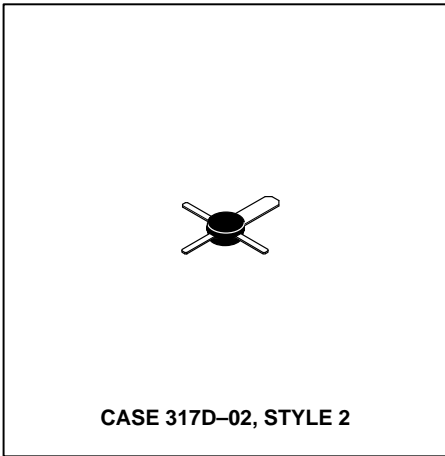
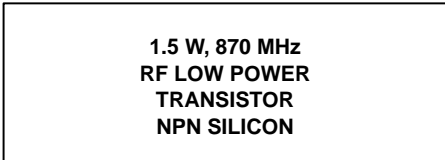


The RF Line

NPN Silicon

RF Low Power Transistor



Designed primarily for wideband large signal predriver stages in the 800 MHz frequency range.

- Specified @ 12.5 V, 870 MHz Characteristics
 - Output Power = 1.5 W
 - Minimum Gain = 8.0 dB
 - Efficiency 60% (Typ)
- Cost Effective PowerMacro Package
- Electroless Tin Plated Leads for Improved Solderability
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	16	Vdc
Collector–Base Voltage	V_{CBO}	36	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	400	mAdc
Total Device Dissipation @ $T_C = 75^\circ\text{C}$ (1, 2) Derate above 75°C	P_D	3.0 40	Watts mW/ $^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	25	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector–Emitter Breakdown Voltage ($I_C = 5.0$ mAdc, $I_B = 0$)	$V_{(BR)CEO}$	16	—	—	Vdc
Collector–Emitter Breakdown Voltage ($I_C = 5.0$ mAdc, $V_{BE} = 0$)	$V_{(BR)CES}$	36	—	—	Vdc
Emitter–Base Breakdown Voltage ($I_E = 0.1$ mAdc, $I_C = 0$)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current ($V_{CE} = 15$ Vdc, $V_{BE} = 0$, $T_C = 25^\circ\text{C}$)	I_{CES}	—	—	0.1	mAdc

ON CHARACTERISTICS

DC Current Gain ($I_C = 100$ mAdc, $V_{CE} = 5.0$ Vdc)	h_{FE}	50	90	200	—
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DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 15$ Vdc, $I_E = 0$, $f = 1.0$ MHz)	C_{ob}	—	3.5	5.0	pF
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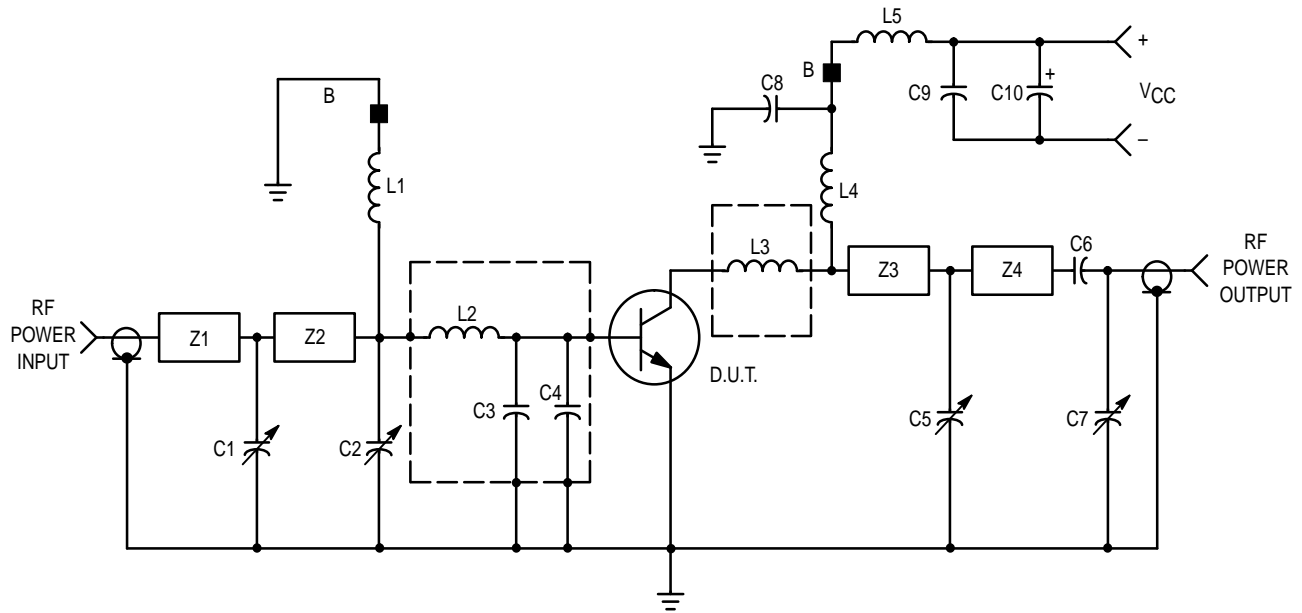
NOTES:

- T_C , Case temperature measured on collector lead immediately adjacent to body of package.
- The MRF557 PowerMacro must be properly mounted for reliable operation. AN938, "Mounting Techniques in PowerMacro Transistor," discusses methods of mounting and heatsinking.

(continued)

ELECTRICAL CHARACTERISTICS — continued ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL TESTS					
Common-Emitter Amplifier Power Gain ($V_{CC} = 12.5\text{ Vdc}$, $P_{Out} = 1.5\text{ W}$, $f = 870\text{ MHz}$)	Figures 1, 2 G_{pe}	8.0	9.0	—	dB
Collector Efficiency ($V_{CC} = 12.5\text{ Vdc}$, $P_{Out} = 1.5\text{ W}$, $f = 870\text{ MHz}$)	Figures 1, 2 η_c	55	60	—	%
Load Mismatch Stress ($V_{CC} = 15.5\text{ Vdc}$, $P_{in} = 225\text{ mW}$, $f = 870\text{ MHz}$, $VSWR \geq 10:1$ all phase angles)	Figures 1, 2 ψ	No Degradation in Output Power			



- C1, C2, C5, C7 — 0.8–8.0 pF Johanson Gigatrim*
- C3, C4 — 15 pF Clamped Mica, Mini-Underwood
- C6 — 27 pF Clamped Mica, Mini-Underwood
- C8 — 91 pF Clamped Mica, Mini-Underwood
- C9 — 68 pF Clamped Mica, Mini-Underwood
- C10 — 1.0 μF , 25 V Tantalum
- B — Bead, Ferroxcube 56-590-65/3B
- PCB — 1/16" Glass Teflon, $\epsilon_r = 2.56$

- L1, L4 — 5 Turns #21 AWG, 5/32" ID
- L2, L3 — 60 x 125 x 250 Mils Copper Tab on
27 Mil Thick Alumina Substrate
- L5 — 7 Turns #21 AWG, 5/32" ID
- Z1 — 1.65 x 0.163" Microstrip, $Z_0 = 50\ \Omega$
- Z2 — 0.85 x 0.163" Microstrip, $Z_0 = 50\ \Omega$
- Z3 — 0.625 x 0.163" Microstrip, $Z_0 = 50\ \Omega$
- Z4 — 1.35 x 0.163" Microstrip, $Z_0 = 50\ \Omega$

*Fixed tuned for broadband response.

Figure 1. 800–880 MHz Broadband Circuit

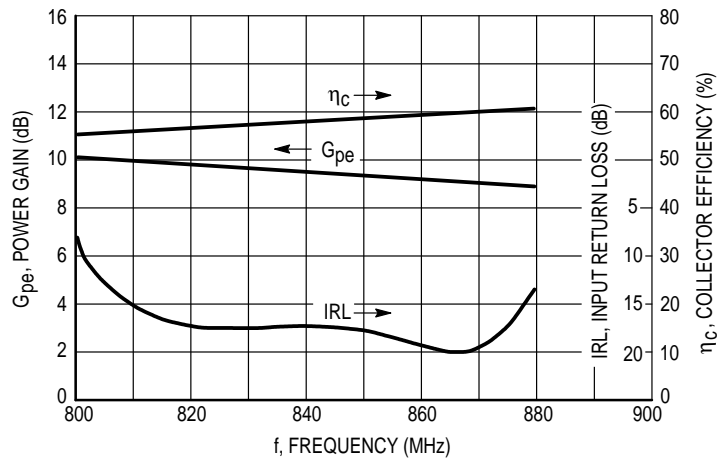


Figure 2. Performance in Broadband Circuit

f Frequency MHz	Z _{in} Ohms		Z _{OL} * Ohms	
	V _{CC} = 7.5 V	V _{CC} = 12.5 V	V _{CC} = 7.5 V	V _{CC} = 12.5 V
	P _{in} = 300 mW	P _{in} = 200 mW	P _{out} 806 MHz = 1.7 W P _{out} 870 MHz = 1.4 W P _{out} 960 MHz = 1.0 W	P _{out} 806 MHz = 2.1 W P _{out} 870 MHz = 1.8 W P _{out} 960 MHz = 1.1 W
806	2.4 + j3.9	2.4 + j3.1	14.7 – j4.4	13.6 – j12.8
870	2.5 + j4.6	2.7 + j3.7	17.2 – j8.6	16 – j13.2
960	6.1 + j7.4	6.8 + j8.3	40 – j8.3	38 – j10.5

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Table 1. Z_{in} and Z_{OL} versus Collector Voltage, Input Power and Output Power

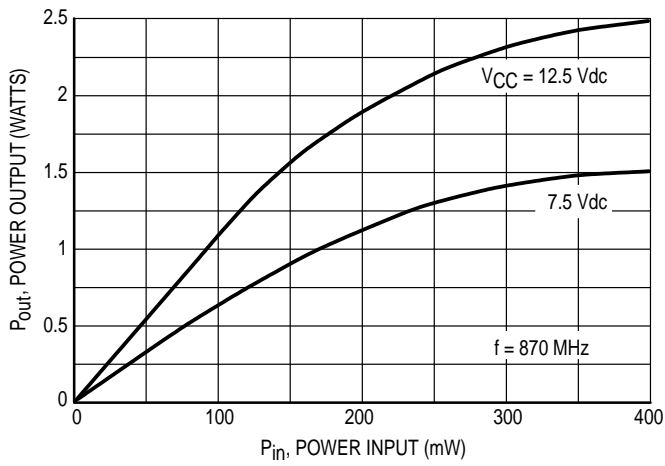


Figure 3. Power Output versus Power Input

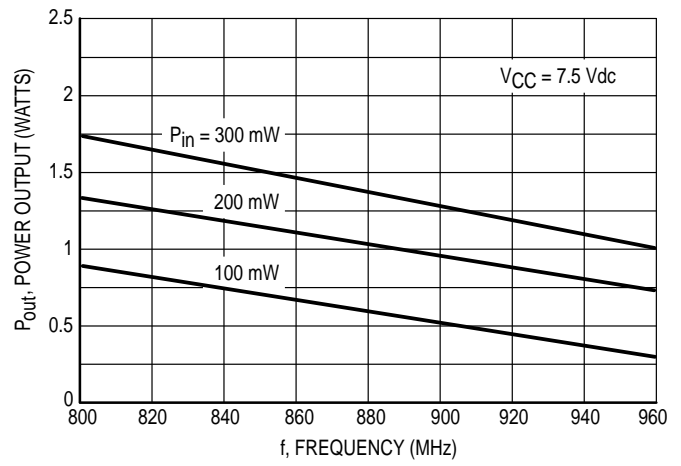


Figure 4. Power Output versus Frequency

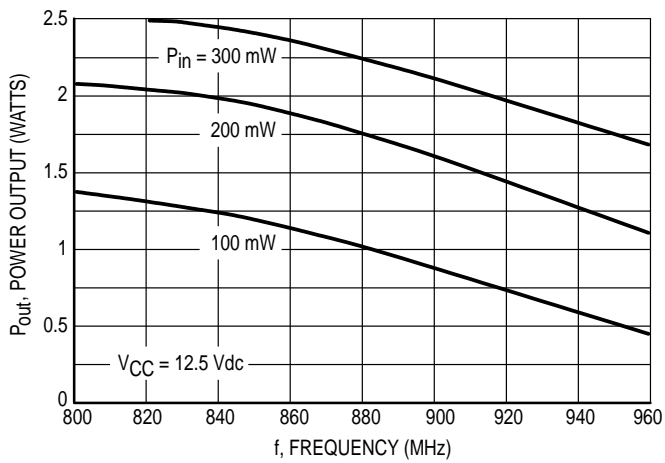


Figure 5. Power Output versus Frequency

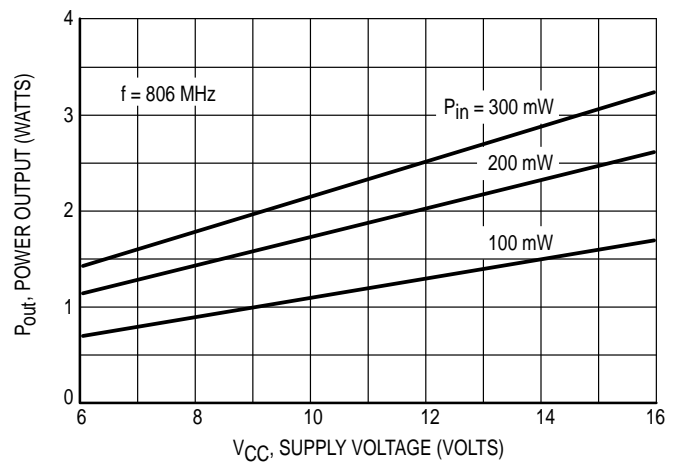


Figure 6. Power Output versus Supply Voltage

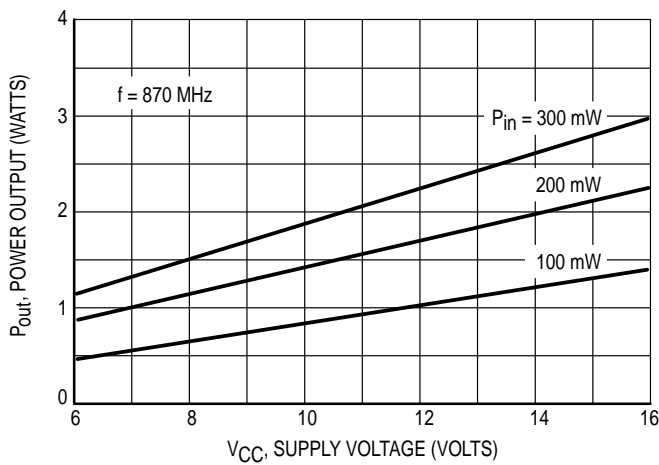


Figure 7. Power Output versus Supply Voltage

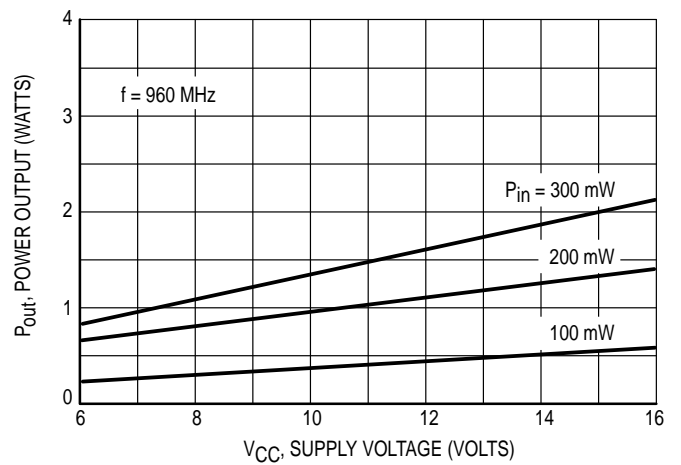
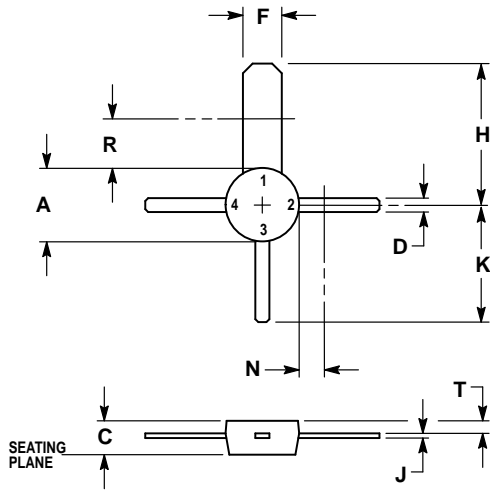


Figure 8. Power Output versus Supply Voltage

PACKAGE DIMENSIONS




- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. LEAD DIMENSIONS UNCONTROLLED WITHIN DIMENSION N AND R.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
C	0.075	0.100	1.91	2.54
D	0.033	0.039	0.84	0.99
F	0.097	0.104	2.46	2.64
H	0.348	0.383	8.84	9.72
J	0.008	0.012	0.24	0.30
K	0.285	0.320	7.24	8.12
N	—	0.065	—	1.65
R	—	0.128	—	3.25
T	0.025	0.040	0.64	1.01

- STYLE 2:
 PIN 1. COLLECTOR
 2. EMITTER
 3. BASE
 4. EMITTER

**CASE 317D-02
 ISSUE C**

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How to reach us:

USA / EUROPE: Motorola Literature Distribution;
P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447

JAPAN: Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, Toshikatsu Otsuki,
6F Seibu-Butsuryu-Center, 3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-3521-8315

MFAX: RMFAX0@email.sps.mot.com - TOUCHTONE (602) 244-6609
INTERNET: <http://Design-NET.com>

HONG KONG: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298



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